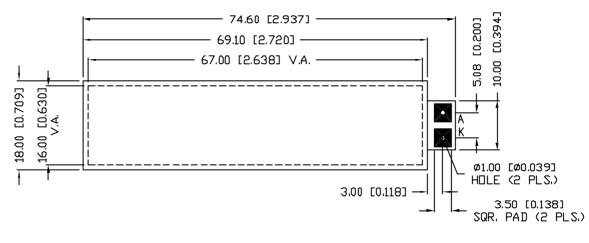
## UNCONTROLLED DOCUMENT

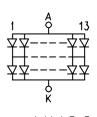
SSB-CC



| ELECTRO-OPTICAL CH | HARACTERIS |
|--------------------|------------|
| PARAMETER          | MIN        |
| PEAK WAVELENGTH    |            |
| FORWARD VOLTAGE    |            |
| REVERSE VOLTAGE    | 8          |
| LUMINOUS INTENSITY |            |
| EMITTED COLOR:     | GREEN      |
| REFLECTOR FINISH:  | WHITE      |

PARAMETER STEADY CURRENT POWER DISSIPATION DERATE FROM 25°C, PER DIE OPERATING, STORAGE TEMP. SOLDERING TEMP. 2.0mm FROM BODY

LIMITS OF SAFE OPERATION AT 2



*UNCONT* 

\*\*UNLESS DTHERWISE SPECIFIED TOLERANCES PER DECINAL PRECISION ARE: X=±1 (±0.039), XX=±0.5 (±0.020), XXX=±0.25 (±0.010), XXXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.

PART NUMBER REV. SSB-COB6716GW-A 67mm x 16mm VIEW AREA, CHIP ON BOARD LED BACKLIGHT,

565nm GREEN, 26 CHIPS, 4.2V @ 130mA.

5.20 [0.205]

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IN PART FROM DISCLOSURE AND DISSEMINATION TO ALL THIRD PARTIES.

0.80 [0.031]

RELIABILITY NOTE

OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT

SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE.

PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.



BC